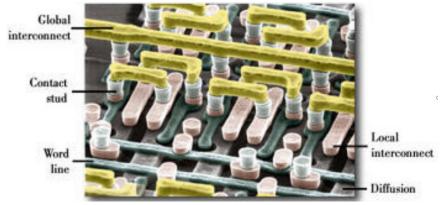
Note: Key characteristics of two different processes are appended at the end of this assignment.

Problem 1 3.1 of Weste and Harris (WH)

Problem 2 3.2 of WH

Problem 3 If a transistor of length 7nm and width 14nm has a gate oxide thickness of 25A°, how many silicon dioxide molecules will be needed for the gate oxide?

Problem 4 A section of global interconnect (See Fig. 3.12 of WH) is shown below where the SiO₂ insulating material has been removed. If this interconnect were made of aluminum and is 1000μm long, 20nm wide, and 40nm thick, what would be the resistance of the interconnect?



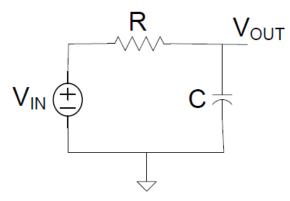
Problem 5 3.5 of WH

Problem 6 How many 12 inch wafers can be obtained from a 2m silicon pull? Assume the kerf width when a wire saw is used is to cut the wafers is 150µm. In solving this problem, state and use a typical value for the wafer thickness.

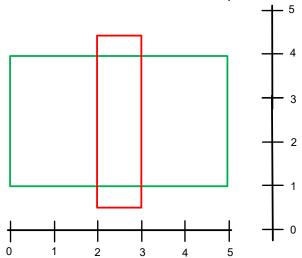
Problem 7 A first-order RC filter is shown. The 3-dB band edge of this filter is given by $\omega_{3dB} = \frac{1}{RC}$. Assume Poly 1 with a silicide block is used to make the resistor and the capacitor is a Poly Insulator Substrate capacitor. This filter is to be fabricated in the TSMC 0.18 μ CMOS process that is characterized by the parameters attached to this assignment.

a) Design this circuit and estimate the area required to implement this filter in your design if the 3dB band edge is to be located at 1K Hz and the capacitor value is 8 pF.

b) If the resistor is too big or the capacitor is too big, the area required to realize this filter becomes very large. Determine the value of R and C that will minimize the total area and compare the area required for the "minimal area" design with that you required in part a). Use a serpentine layout for the resistor.



Problem 8 Consider the layout of a transistor shown below where red is polysilicon and green is n-active. Rulers with dimensions in µm are shown.



- a) What is the drawn length and width of the transistor?
- b) Assume positive photoresist is used pattern the polysilicon region to protect it during the polysilicon etch. If the photoresist is under-exposed so that the edges move by 0.1 µm from the desired location and the photoresist development is perfect, and the polysilicon is under-etched so that the edges move by 0.1 µm, what will be the actual length and width of the transistor? (neglect any lateral diffusion that may occur)
- c) Repeat part b) if negative photoresist is used.

Problem 9 An aluminum interconnect 250 μ m long and 2μ m wide has a measured resistance of 25 Ω . Determine the thickness of the aluminum interconnect and the sheet resistance. If a copper interconnect has the same thickness and the same width

as the aluminum interconnect, how long would it be if it also had the same resistance?

Problem 10 Thermal oxide growth of field oxide causes the wafer surface to become somewhat nonplanar. If 5000Å of field oxide is thermally grown, what is the difference in the thickness of the wafer between regions where field oxide is present and where it is absent. In solving this problem, state and use a typical value for the wafer thickness.

Measured Parameters for an ON $0.5\mu m$ CMOS Process

MINIMUM Vth	3.0)/0.6	0.	78	-0.	.93	vol	ts		
SHORT Idss Vth Vpt	20.	0/0.6	0.		-238 -0. -10.	.90	vol	ts		
WIDE Ids0	20.	0/0.6	< 2.	5	< 2.	. 5	pA/	um		
LARGE Vth Vjbkd Ijlk Gamma	50/	′50	11.4	4	<50.	. 7	vol pA	ts		
K' (Uo*Cox/2) Low-field Mobility			56. 474.		-18. 153.			V^2 2/V*s		
COMMENTS: XL_AMI_C5F										
FOX TRANSISTORS Vth	GAT Pol		N+ACTIV >15.0							
PROCESS PARAMETERS Sheet Resistance Contact Resistance Gate Oxide Thickness	82.7 56.2	103.2	21.7		_HR		7		0.09 0.78	ohms/sq
PROCESS PARAMETERS Sheet Resistance Contact Resistance		MTL3 0.05 0.78	N\PLY 824		N_WEI 815	LL	UNI ohm ohm	ıs/sq		

COMMENTS: N\POLY is N-well under polysilicon.

CAPACITANCE PARAMETERS Area (substrate) Area (N+active) Area (P+active)	N+ACTV 429	P+ACTV 721	POLY 82 2401 2308	POLY2	M1 32 36	M2 17 16	M3 10 12	N_WELL 40	UNITS aF/um^2 aF/um^2 aF/um^2
Area (poly)				864	61	17	9		aF/um^2
Area (poly2)					53				aF/um^2
Area (metal1)						34	13		aF/um^2
Area (metal2)							32		aF/um^2
Fringe (substrate)	311	256			74	58	39		aF/um
Fringe (poly)					53	40	28		aF/um
Fringe (metal1)						55	32		aF/um
Fringe (metal2)							48		aF/um
Overlap (N+active)			206						aF/um
Overlap (P+active)			278						aF/um

MOSIS WAFER ACCEPTANCE TESTS for TSMC 0.18 μm CMOS Process

RUN: T4BK (MM_NON-EPI_THK-MTL) VENDOR: TSMC

TECHNOLOGY: SCN018 FEATURE SIZE: 0.18 microns

INTRODUCTION: This report contains the lot average results obtained by MOSIS from measurements of MOSIS test structures on each wafer of this fabrication lot. SPICE parameters obtained from similar measurements on a selected wafer are also attached.

COMMENTS: DSCN6M018 TSMC

TRANSISTOR PARAMETERS	W/L	N-CHANNEL P-	CHANNEL	UNITS
MINIMUM Vth	0.27/0.18	0.50	-0.53	volts
SHORT Idss Vth Vpt	20.0/0.18	571 0.51 4.7	-266 -0.53 -5.5	uA/um volts volts
WIDE Ids0	20.0/0.18	22.0	-5.6	pA/um
LARGE Vth Vjbkd Ijlk	50/50	0.42 3.1 <50.0	-0.41 -4.1 <50.0	volts volts pA
<pre>K' (Uo*Cox/2) Low-field Mobility</pre>		171.8 398.02	-36.3 84.10	uA/V^2 cm^2/V*s

COMMENTS: Poly bias varies with design technology. To account for mask bias use the appropriate value for the parameters ${\tt XL}$ and ${\tt XW}$ in your SPICE model card.

	Desi	gn Tech	nology	XL	(um)	XW (um)		
		GCN6M_DEEP (lambda=0.09) thick oxide GCN6M_SUBM (lambda=0.10) thick oxide				0.0 0.0 -0.0	-0.01 -0.01 0.00 0.00	
FOX TRANSISTORS Vth	_	ATE oly	-	TIVE P	+ACTIVE <-6.6	UNITS volts		
PROCESS PARAMETERS Sheet Resistance Contact Resistance Gate Oxide Thickness	N+ 6.6 10.1 40	P+ 7.5 10.6	7.7 9.3	N+BLK 61.0	PLY+BLK 317.1	M1 0.08	M2 0.08 4.18	-
PROCESS PARAMETERS Sheet Resistance Contact Resistance COMMENTS: BLK is silic	M3 0.08 8.97 cide b	POLY_H 991.5 lock.		M4 0.08 14.09	м5 0.08 18.84	м6 0.01 21.44	N_W 941	UNITS ohms/sq

CAPACITANCE PARAMETERS

	N+	P+	POLY	M1	M2	М3	M4	M5	M6	R_W	D_N_W	M5P	N_W	UNITS
Area (substrate)	998	1152	103	39	19	13	9	8	3		129		127	aF/um^2
Area (N+active)			8566	54	21	14	11	10	9					aF/um^2
Area (P+active)			8324											aF/um^2
Area (poly)				64	18	10	7	6	5					aF/um^2
Area (metal1)					44	16	10	7	5					aF/um^2
Area (metal2)						38	15	9	7					aF/um^2
Area (metal3)							40	15	9					aF/um^2
Area (metal4)								37	14					aF/um^2
Area (metal5)									36			1003		aF/um^2
Area (r well)	987													aF/um^2
Area (d well)										574				aF/um^2
Area (no well)	139													aF/um^2
Fringe (substrate) 244	201		18	61	55	43	_						aF/um
Fringe (poly)				69	39	29	24		-					aF/um
Fringe (metal1)					61	35		23						aF/um
Fringe (metal2)						54	37							aF/um
Fringe (metal3)							56							aF/um
Fringe (metal4)								58						aF/um
Fringe (metal5)									61					aF/um
Overlap (P+active	e)		652											aF/um

CIRCUIT PARAME	TERS		UNITS
Inverters	K		
Vinv	1.0	0.74	volts
Vinv	1.5	0.78	volts
Vol (100 uA)	2.0	0.08	volts
Voh (100 uA)	2.0	1.63	volts
Vinv	2.0	0.82	volts
Gain	2.0	-23.33	
Ring Oscillator Fre	eq.		
D1024_THK (31-9	stg,3.3V)	338.22	MHz
DIV1024 (31-stg,	1.8V)	402.84	MHz
Ring Oscillator Po	wer		
D1024_THK (31-9	stg,3.3V)	0.07	uW/MHz/gate
DIV1024 (31-stg,	1.8V)	0.02	uW/MHz/gate

COMMENTS: DEEP_SUBMICRON

```
SPICE 3f5 Level 8, Star-HSPICE Level 49, UTMOST Level 8
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* LOT: T4BK
                          WAF: 3004
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                                              TOX
                                                   = 4E - 9
+XJ = 1E-7
                      NCH
                             = 2.3549E17
                                              VTH0 = 0.3662648
+K1
       = 0.5802748
                      K2
                             = 3.124029E-3 K3
                                                    = 1E-3
+K3B
                              = 1E-7
                                            NLX
                                                    = 1.766159E-7
       = 3.3886871
                       WΟ
                                             DVT2W = 0
+DVTOW = 0
                      DVT1W = 0
+DVT0 = 1.2312416
                      DVT1 = 0.3849841
                                             DVT2 = 0.0161351
                             = -1.506402E-9 UB = 2.489393E-18
+U0
       = 265.1889031 UA
      = 5.621884E-11 VSAT = 1.017932E5 A0
= 0.4543117 B0 = 3.433489E-7 B1
+UC
                                                    = 2
+AGS
                                                    = 5E-6
                            = 1.158074E-3 A2
                                                    = 1
      = -0.0127714
                      A1
+KETA
                                             PRWB = -0.2
       = 136.5582806
                       PRWG = 0.5
+RDSW
                     WINT = 0

XW = -1E-8

VOFF = -0.0948017

CDSCD = 0
                                            LINT = 1.702415E-8
DWG = -4.211574E-9
+WR
       = 1
+XL
       = 0
      = 1.107719E-8
+DWB
+CIT
       = 0
                      ETA0 = 3.335516E-3 ETAB = 6.028975E-5

PCLM = 0.6602119 PDIBLC1 = 0.1605325

PDIBLCB = -0.1 DROUT = 0.7917811
+CDSCB = 0
+DSUB = 0.0214781
+PDIBLC2 = 3.287142E-3 PDIBLCB = -0.1
+PSCBE1 = 6.420235E9 PSCBE2 = 4.122516E-9 PVAG = 0.0347169
+DELTA = 0.01
                      RSH = 6.6 MOBMOD = 1
                      UTE
                                            KT1 = -0.11
+PRT
      = 0
                             = -1.5
                             = 0.022
      = 0
                      KT2
                                                    = 4.31E-9
+KT1L
                                            UA1
                                            AT
                             = -5.6E-11
+UB1
      = -7.61E-18
                      UC1
                                                    = 3.3E4
                                             WW
+WL
       = 0
                       WLN
                             = 1
                                                    = 0
+WWN
       = 1
                       WWL
                              = 0
                                             _{
m LL}
                                                     = 0
                                             LWN
+LLN
       = 1
                       LW
                              = 0
                                                    = 1
       = 0
                       CAPMOD = 2
+LWL
                                             XPART = 0.5
+CGDO
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                      CGSO = 8.06E-10
                                            CGBO = 1E-12
                             = 0.8
+CJ
       = 9.895609E-4
                      PB
                                            MJ
                                                    = 0.3736889
                                            MJSW = 0.1537892
       = 2.393608E-10 PBSW = 0.8
+CJSW
                       PBSWG = 0.8
                                             MJSWG = 0.1537892
+CJSWG = 3.3E-10
                       PVTHO = -1.73163E-3 PRDSW = -1.4173554
+CF
       = 0
+PK2
       = 1.600729E-3 WKETA = 1.601517E-3
                                             LKETA = -3.255127E-3
+PUO = 5.2024473 PUA = 1.584315E-12 PUB = 7.446142E-25
+PVSAT = 1.686297E3 PETAO = 1.001594E-4 PKETA = -2.039532E-3
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```

```
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                     NCH = 4.1589E17
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     = 1E-7
+XJ
                                         VTH0
                   K2
       = 0.5895473
                           = 0.0235946
                                         K3
+K1
                    WΟ
      = 13.8642028
                           = 1E-6
                                               = 1.517201E-7
+K3B
                                         NLX
+DVTOW = 0
                    DVT1W = 0
                                         DVT2W = 0
+DVT0
     = 0.7885088
                    DVT1 = 0.2564577
                                        DVT2 = 0.1
      = 103.0478426
+110
                    IJΑ
                          = 1.049312E-9 UB
                                               = 2.545758E-21
                                        ΑO
+UC
      = -1E-10
                    VSAT = 1.645114E5
                                               = 1.627879
                     В0
                           = 5.207699E-7
+AGS
      = 0.3295499
                                         В1
                                               = 1.370868E-6
                                               = 0.3
+KETA
      = 0.0296157
                    Α1
                           = 0.4449009
                                         A2
+RDSW = 306.5789827
                    PRWG = 0.5
                                         PRWB = 0.5
+WR
      = 1
                     WINT = 0
                                         LINT = 2.761033E-8
+XL
      = 0
                     XW
                          = -1E-8
                                        DWG
                                              = -2.433889E-8
                   VOFF = -0.0867009
+DWB
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                     CDSC = 2.4E-4
+CIT
                                         CDSCD = 0
                                        ETAB = -3.206319E-4
                     ETA0
+CDSCB
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                           = 1.018318E-3
                    PCLM = 1.3281073
+DSUB = 1.094521E-3
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                                         DROUT = 0
+PDIBLC2 = -3.255915E-6 PDIBLCB = -1E-3
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                                        PVAG = 2.0932623
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+PRT
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                     UTE
                           = -1.5
                                        KT1 = -0.11
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                                        UA1
                                               = 4.31E-9
+UB1
      = -7.61E-18
                                        AT
                     UC1
                           = -5.6E - 11
                                                = 3.3E4
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                     WLN
                                         WW
+WWN
      = 1
                     WWL
                           = 0
                                               = 0
                                         LL
                           = 0
+LLN
      = 1
                     LW
                                         LWN
                                               = 1
      = 0
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                                        CGBO = 1E-12
      = 1.157423E-3 PB
                                        MJ
                                               = 0.4063933
                           = 0.8444261
+CJ
       = 1.902456E-10
                    PBSW
                           = 0.8
                                         MJSW
                                               = 0.3550788
+CJSW
+CJSWG
      = 4.22E-10
                     PBSWG = 0.8
                                        MJSWG = 0.3550788
      = 0
                     PVTH0 = 1.4398E-3
+CF
                                        PRDSW = 0.5073407
+PK2
      = 2.190431E-3
                    WKETA = 0.0442978
                                        LKETA = -2.936093E-3
                          = -4.34529E-11 PUB = 1E-21
      = -0.9769623
                    PUA
+PVSAT = -50
                     PETA0 = 1.002762E-4
                                        PKETA = -6.740436E-3
)
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